

# **BESIII - Preventivi 2023**

**Consiglio di Sezione - Sezione di Ferrara, 1 Luglio 2022**

**I. Garzia**

# Anagrafica del gruppo

	<b>Cognome</b>	<b>Nome</b>	<b>Qualifica</b>	<b>Responsabilità</b>	<b>BESIII</b>
Phys	Balossino	Ilaria	fellow IHEP	responsabile operation CGEM	0.7
Phys	Bettoni	Diego	ricercatore		1
Phys	Cibinetto	Gianluigi	ricercatore	tech. board, system manage CGEM	0.5
Phys	Farinelli	Riccardo	AdR		0.3
Phys	Garzia	Isabella	ricercatore Unife	convener LH, CIF	0.6
Phys	Gramigna	Stefano	dottorando		0.9
Phys	Mezzadri	Giulio	AdR		0.7
Phys	Scodeggio	Marco	dottorando		0.8

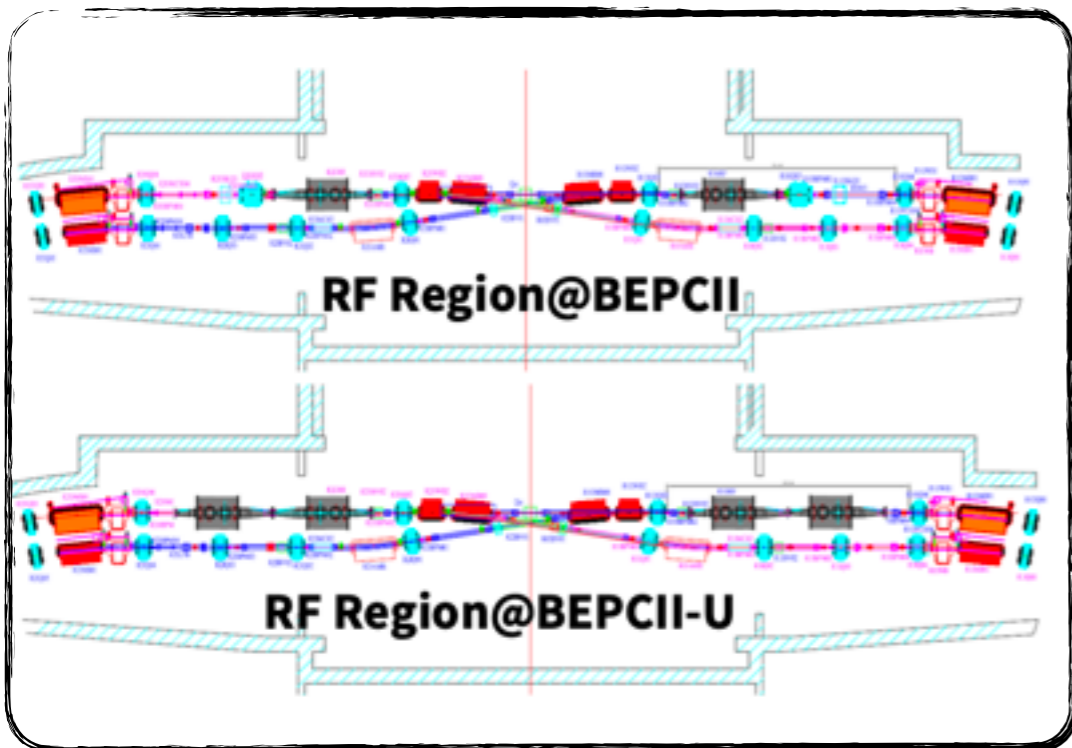
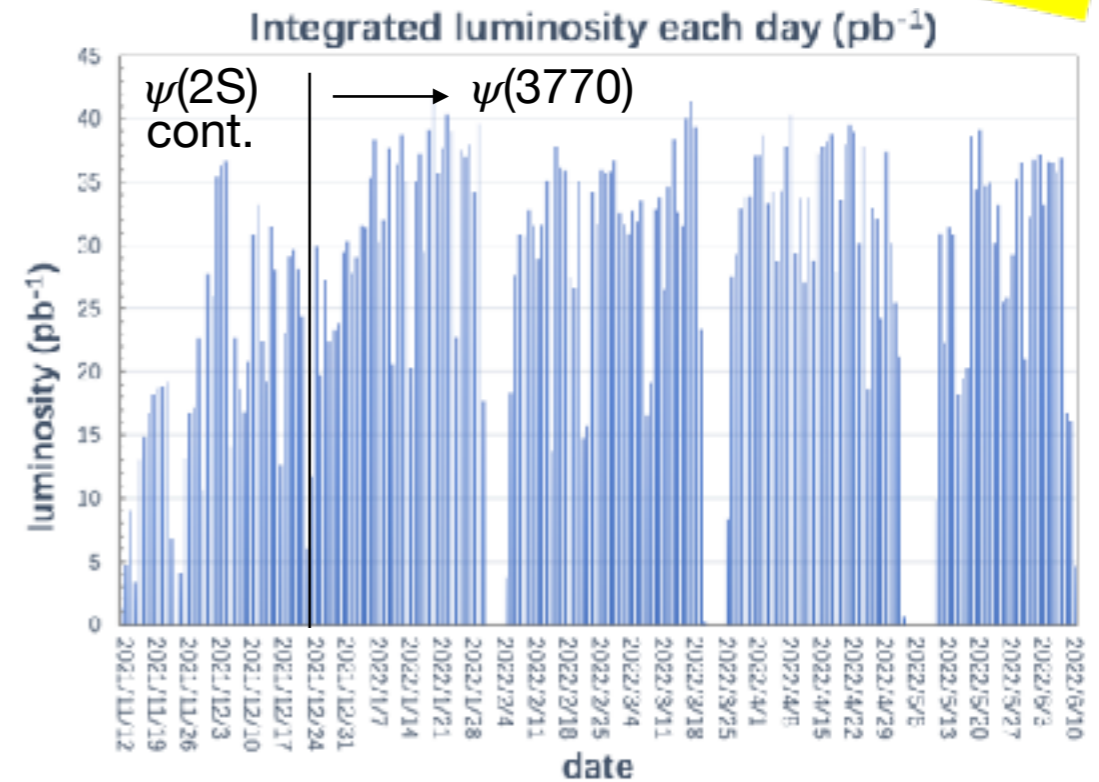
<b>Totale 2023 (Phys)</b>	<b>5.5</b>
Totale 2022/2021 (solo fisici)	<b>5.35/5.45</b>
Totale 2022/2021 (Phys+Tech)	6.45/6.65

**Fondamentale il supporto dei servizi di meccanica ed elettronica**

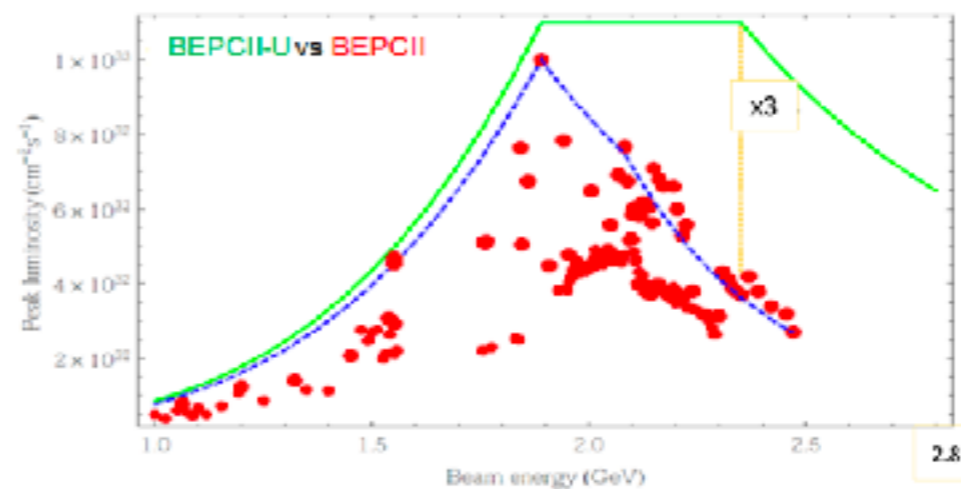
# Stato dell'esperimento

World largest  
J/ψ, ψ(2S) and  
ψ(3770) samples

- Presa dati anno in corso: 400 pb<sup>-1</sup> @ 3.65 GeV e 3.682 GeV (continuum data) + 4.8 fb<sup>-1</sup> @ ψ(3770)
  - Turni online + presenza (cinesi) 2021/2022
  - La situazione pandemica non ha influenzato il piano di presa dati
  - Presa dati per i prossimi anni già programmata
- Luglio-Dicembre 2024: shutdown per l'upgrade di BEPCII



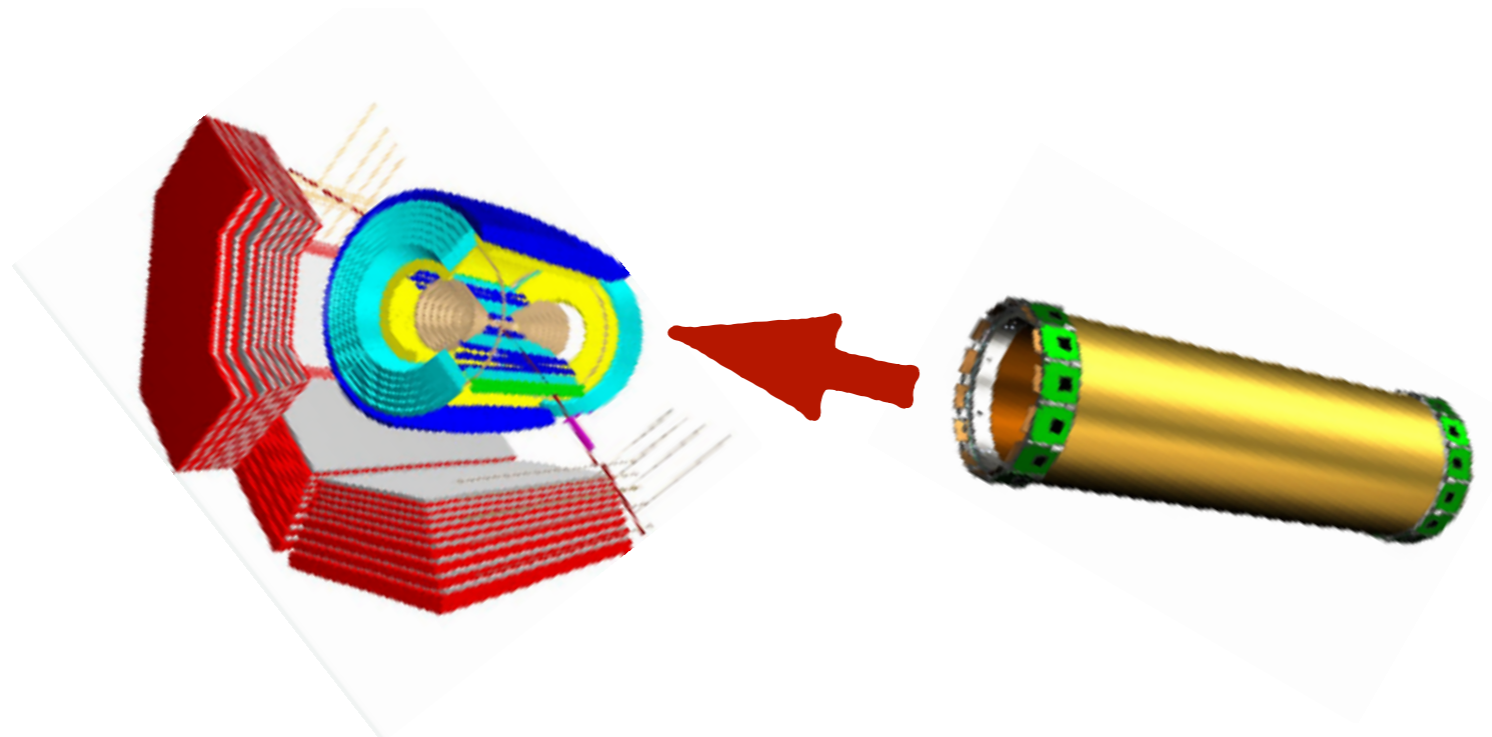
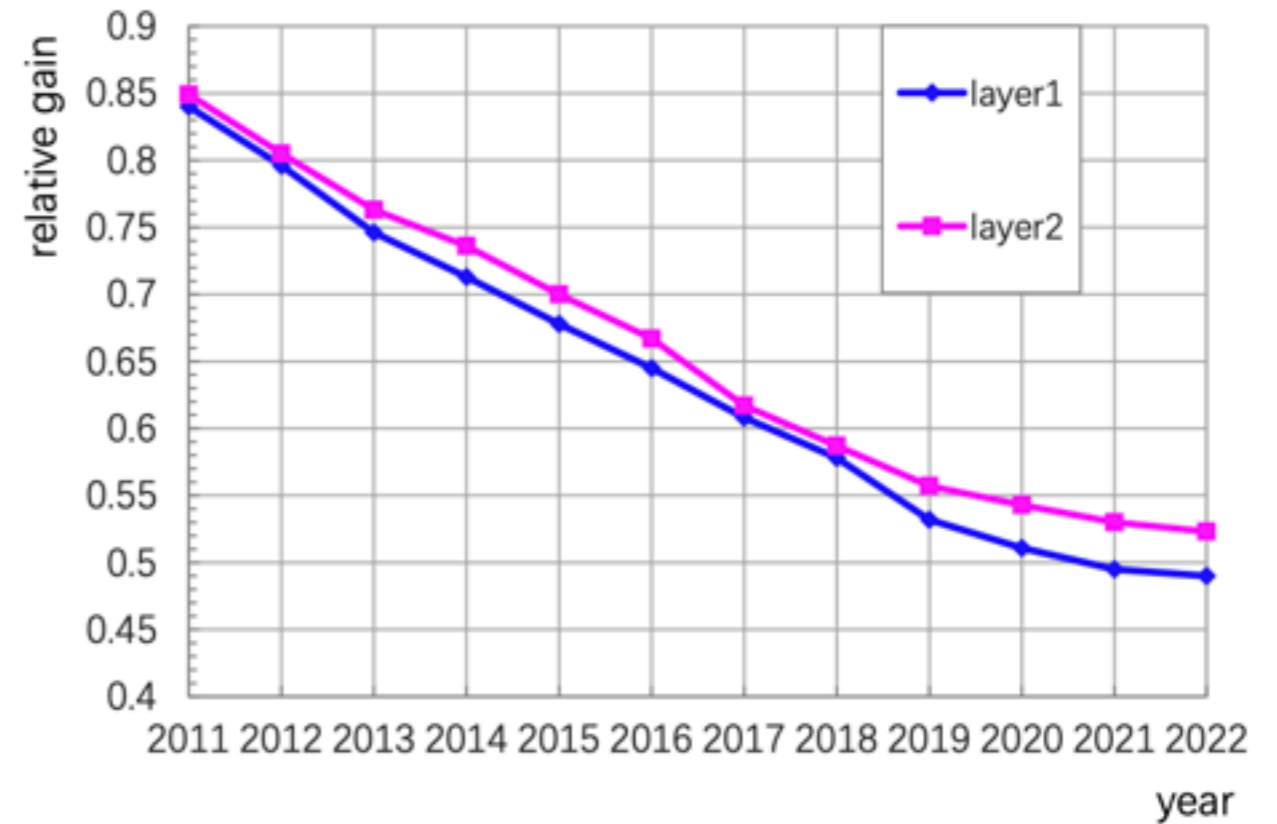
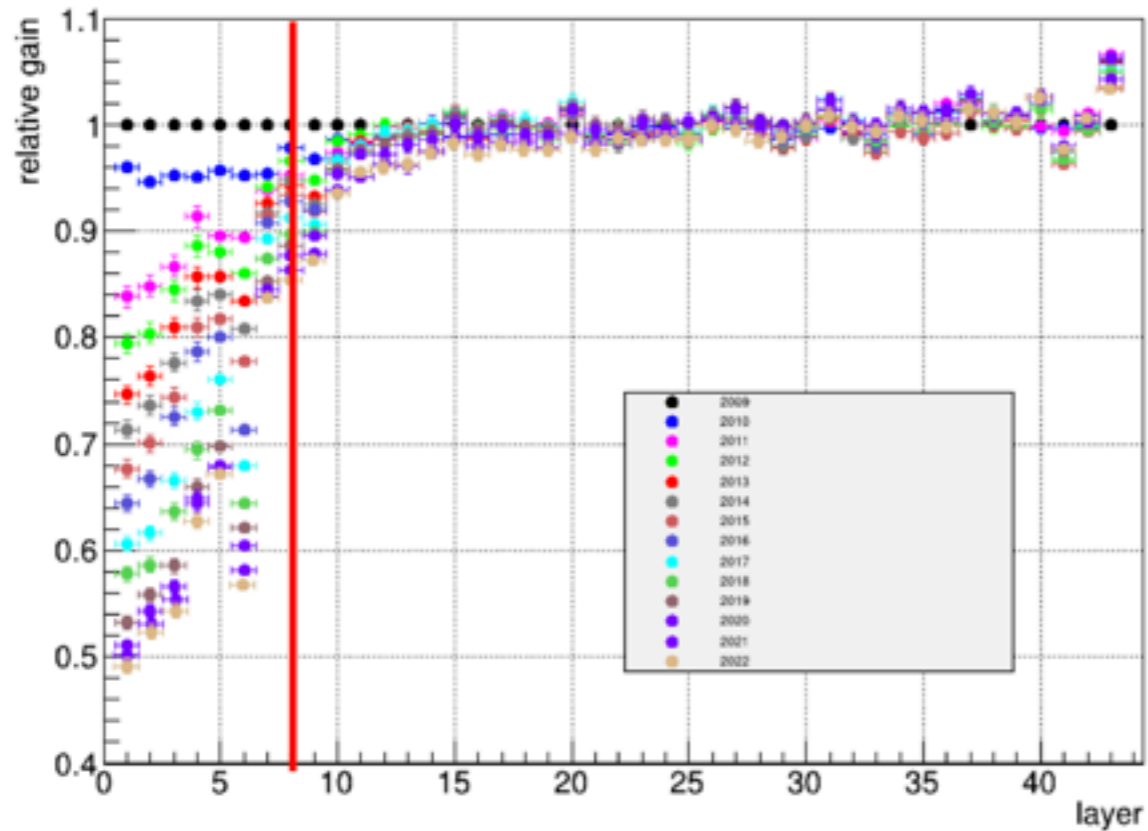
- Aggiunta cavità risonante
- Migliorare l'ottica per incrementare il numero di pacchetti
- Sfida: aumento intensità del fascio e background del rivelatore



- XYZ states
- charmed baryon/meson pairs
- Hadronic FF
- CP violation in charmed baryon decays

# Stato dell'esperimento

## Inner MDC:



## CGEM project

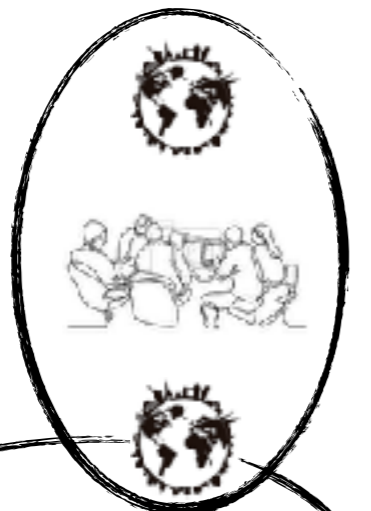
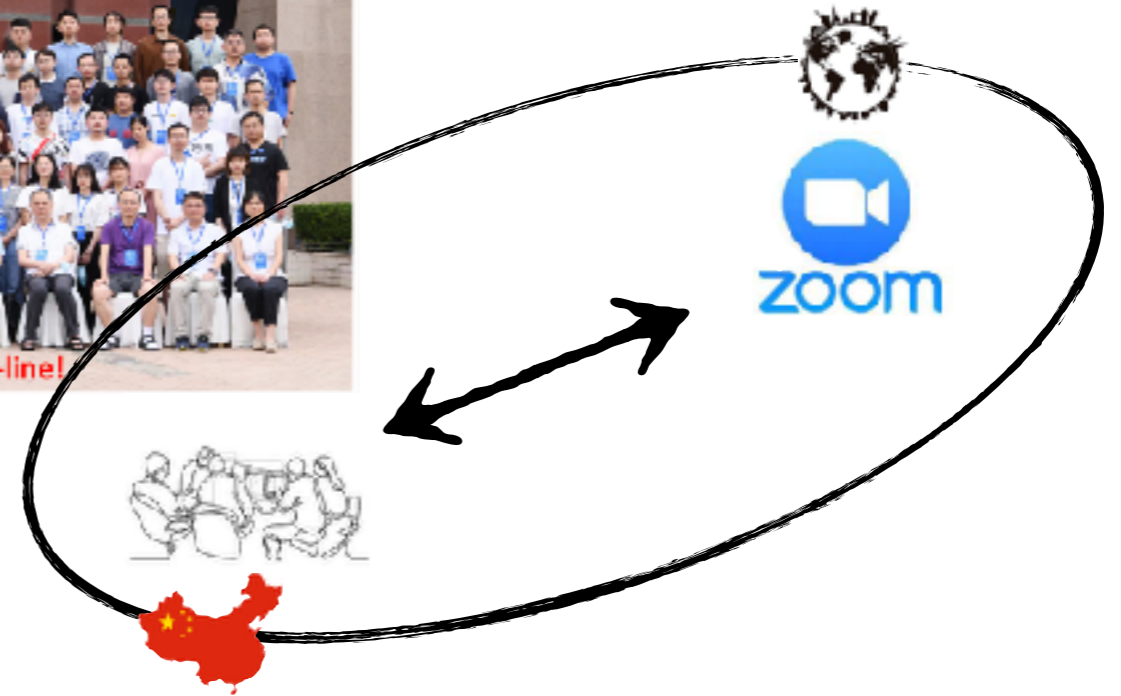
**Luglio-Dicembre 2024**  
**(presa dati fino al 2030)**

# Impatto COVID - 19 su BESIII

THE BESIII COLLABORATION MEETING IN SUMMER OF 2021  
2021年北京谱仪III国际合作组夏季会议合影 2021.6.28 甘肃·兰州

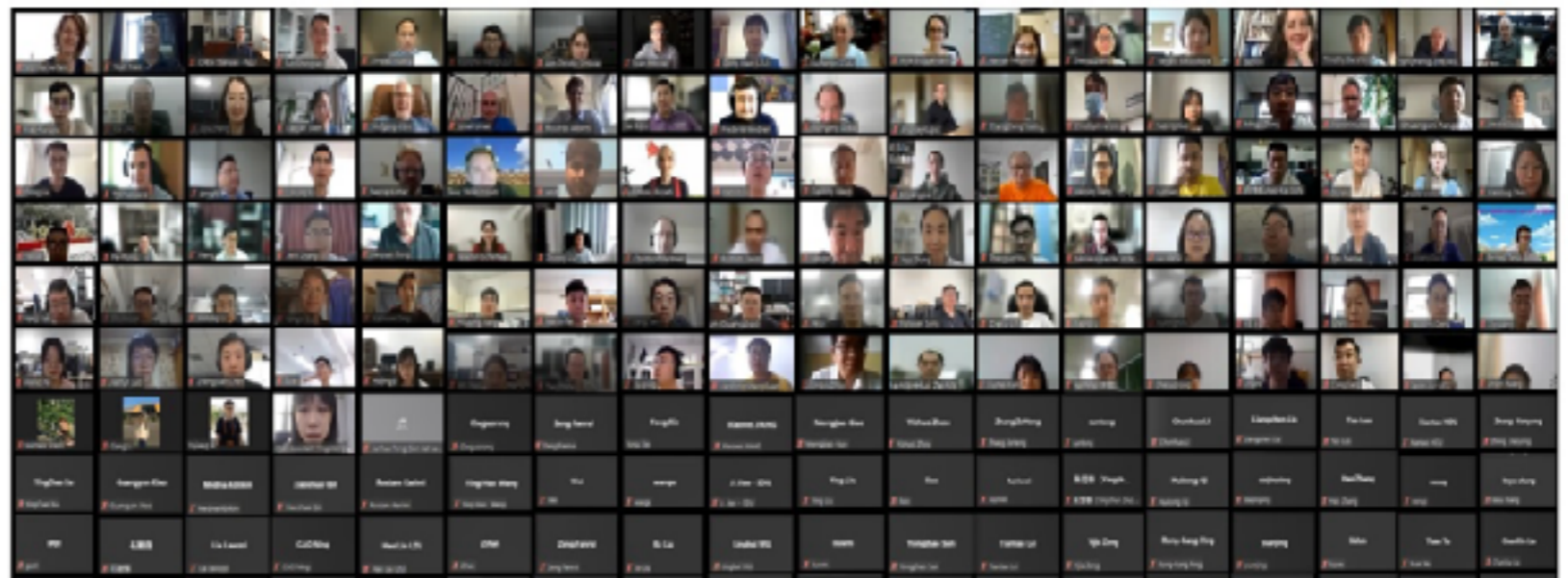


More than 200 people attend the meeting in person + more than 50 colleagues on-line!



BESIII

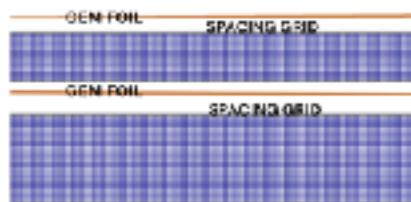
**BESIII Collaboration Meeting in Summer 2022**  
**June 13-17, 2022, ONLINE**



# Attività 2023: hardware (1)

- Layer1&2 @ Beijing (ultima accensione 13 Aprile 2022)  
Appena ci sarà la possibilità di rientrare a Beijing: operazioni per il mantenimento, integrazione e commissioning

- Disegno e costruzione Layer3: situazione attuale



Vertical Assembly



**Preliminary Gluing Tests**

- Planar Gluing of Kapton samples
- Honeycomb and Carbon fiber in the cylindrical shape

**Spacing Grids Preparation**

## Mockup Construction

**Electrodes Preparation**

**Mechanical Structure**

### Future operations

- ▶ Regularly power on the detectors
- ▶ Run Stability Tests
- ▶ Check the chiller pump - turn it on at first
- ▶ Change the GEMROC's firmware - to update the system
- ▶ Checks on detector's HV instability
- ▶ CGEM-IT Moving

**AS SOON AS T&H ARE OK**

**AS SOON AS THE SITUATION IS MORE STABLE**

**AS SOON AS WE CAN TRAVEL BACK TO BEIJING**

Drop test



CT Scan

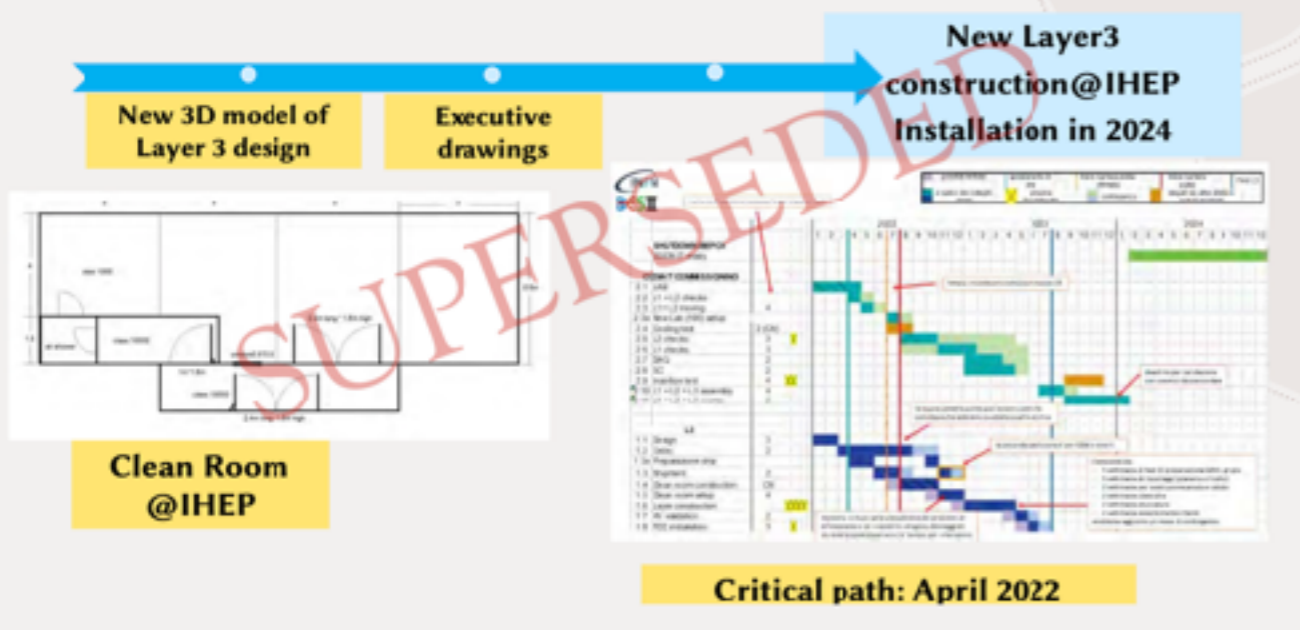


# Attività 2023: hardware (1)

- Costruzione Layer3: piani per il 2023

## Plan for full construction at IHEP

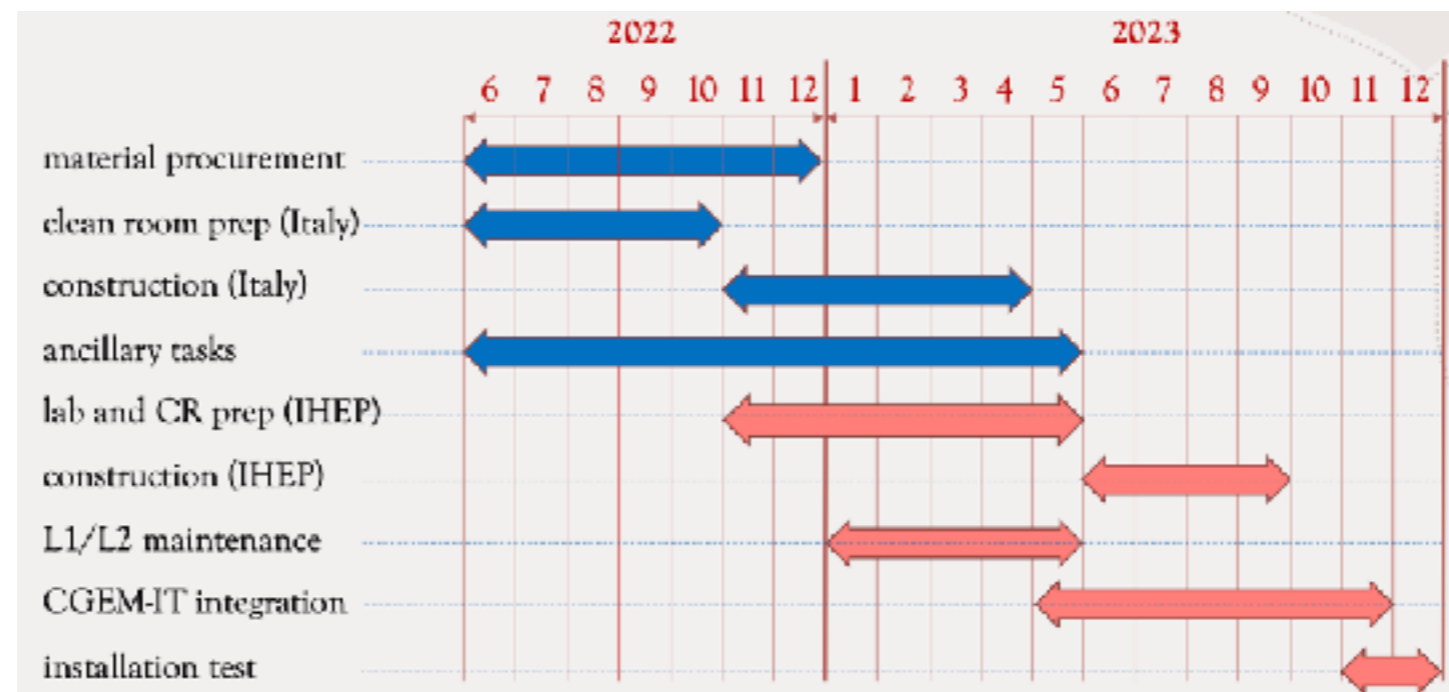
G. Cibinetto



## Hybrid construction

- Single cylindrical elements built in Italy
  - Early 2023
  - Clean Room options under discussion (about 25 m<sup>2</sup>)
- Vertical assembly at IHEP
  - Mid 2023
  - Upgrade of current Clean Rooms (NO enlargement needed)
  - Upgrade of the vertical tool alignment systems needed

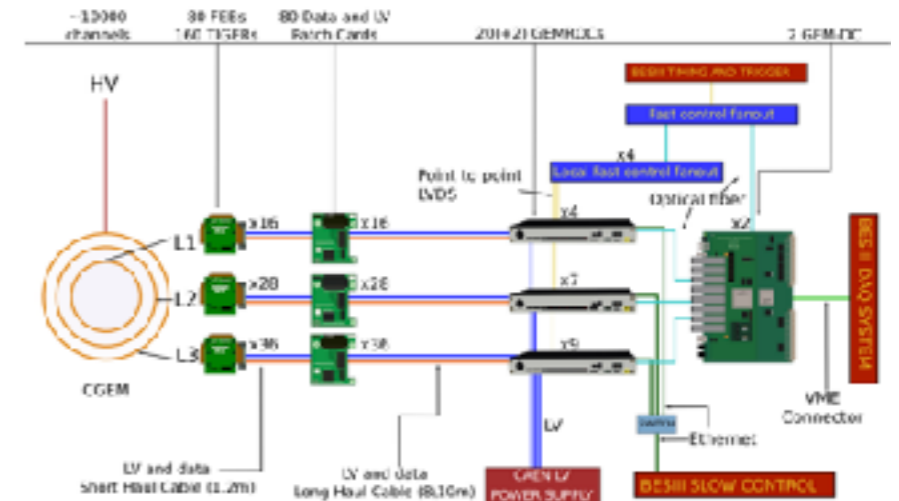
International Travels must be restored by end of 2022



# Attività 2023: elettronica e software (II)

## ELETTRONICA

- Preparare le GEMROC necessarie per completare la catena di lettura
  - sostituzione ArrivaV GX development kit
- Finalizzazione dei disegni dei racks per l'installazione dei moduli GEMROC e cavi nella hall di BESIII
- Sistema FCS FANOUT modulare basato sulle GEMROC: verrà testato prima in Italia e successivamente a Beijing



## DATA TAKING

- Presa dati: **online** o in presenza?

## SOFTWARE

- Aggiornamento geometria L3
- Test e debug del software di tracciamento
- Calibrazioni temporali
- Ottimizzazione  $\mu$ TPC

## OFF-DETECTOR >GEMROC

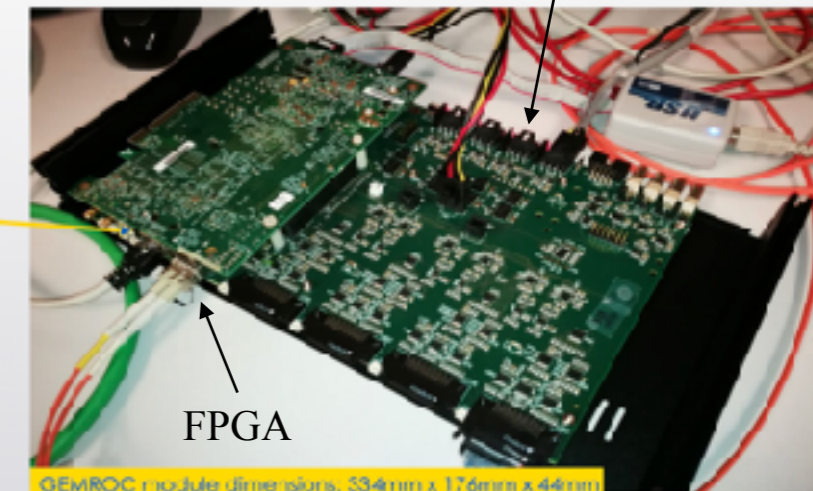
Interface Card (A.C.R.) +  
ArrivaV GX development kit (DK-START-5AGX33N)



We have enough spares  
but ArrivaV is discontinued

A. Costa Ramusino@INFN Ferrara

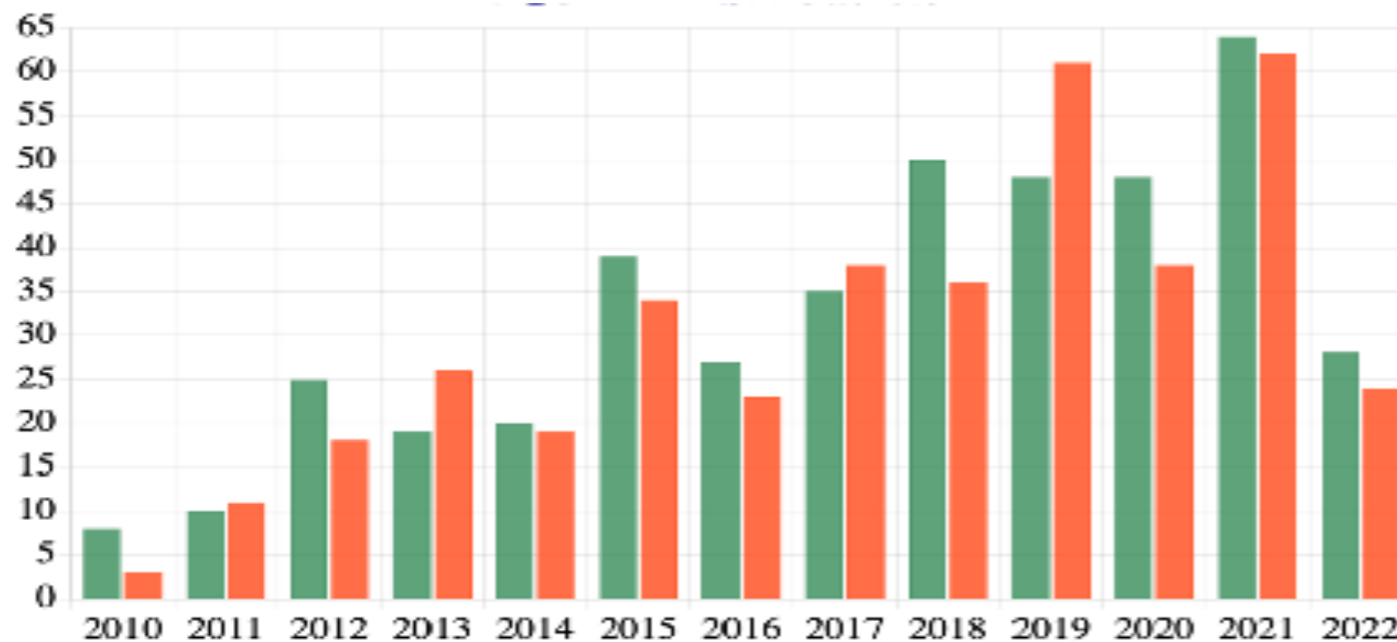
interface board



GEMROC module dimensions: 334mm x 176mm x 44mm



# Attività 2022: analisi (III)



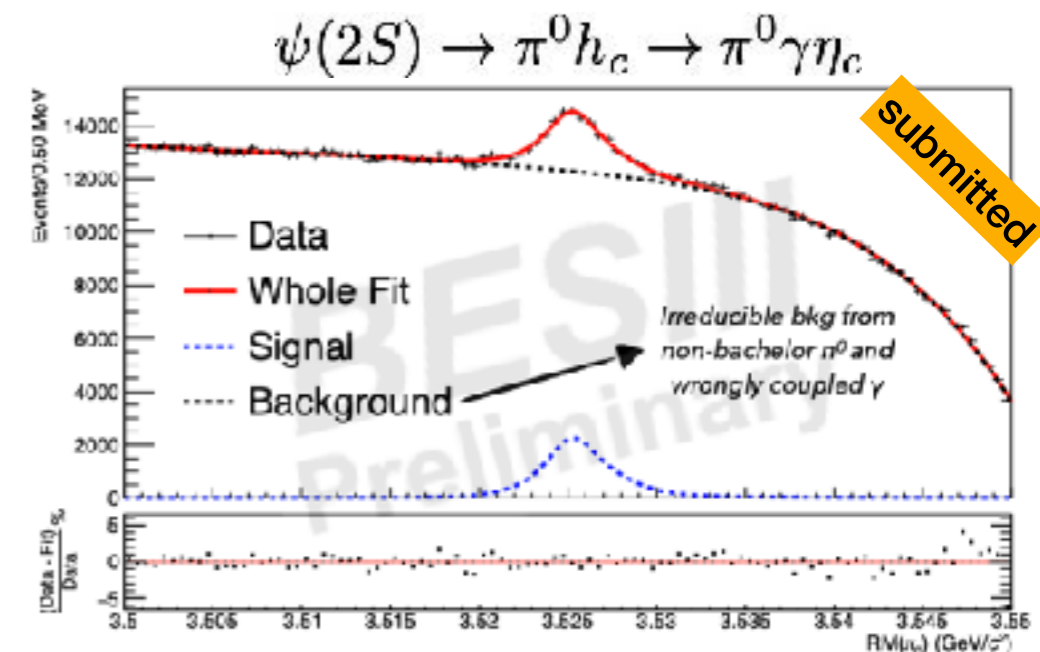
\*ai primi di Giugno 2022

Sottomesse (2022): 23

Pubblicate (2022): 21

Physics Analysis ongoing from Ferrara group:

- **Relative phase for  $\psi(2S)$** : finish the analysis for  $e^+e^- \rightarrow J/\psi \pi \pi$  (advanced state) and then proceed to other analysis sharing the task with the Collaboration
- **Charmonium**:
  - Measurement of  $h_c$  mass and width: **submitted on PRD**
  - Search for the  $Z_c(4430)$  in  $Y(4460)$  decay: PhD thesis of M. Scodreggio
- **LFVU** with  $\psi(2S) \rightarrow \tau \tau$
- **Search for hidden strangeness pentaquark**: use the recent collected data to improve the statistics



# Richieste Finanziarie

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## Richieste per missioni

- ~ **100 k€**
  - riunioni di coordinamento CGEM, software, fisica; Collaboration Meeting; periodi lavoro fuori sede, ...

## Finanziamenti esterni

- ~ **100 k€** FEST-project MSCA-RISE 2019 (anni 2020-2023)

## Costruzione ed apparati

- ~ **30 k€** - (soggetti a definizione progetto e preventivi)
  - costruzione e test

**Grazie per l'attenzione**



# Tecnologi: Anagrafica 2022

	<b>Cognome</b>	<b>Nome</b>	<b>Qualifica</b>	<b>Responsabilità</b>	<b>BESIII</b>	
Tec. Elec.	Cotta Ramusino	Angelo	tecnologo		0.1	
Tec. Elec.	Chiozzi	Stefano	tecnico		0.1	
Tec. Elec.	Malaguti	Roberto	tecnico		0.1	
Tec. Elec.	Magnani	Andrea	tecnico		0.2	
Tec. Elec.	Neri	Ilaria	tecnico		0.1	<b>tot=0.6</b>
Tec. Mech.	Carassiti	Vito	tecnologo		0.2	
Tec. Mech.	Cavallina	Michele	tecnico		0.1	
Tec. Mech.	Melchiorri	Michele	tecnico	responsabile meccanica	0.2	<b>tot=0.5</b>

<b>Totale (Phys+tec.)</b>	<b>6.45</b> (6.65 per 2021)
<b>Totale solo Phys.</b>	<b>5.35</b> (5.45 per 2021)

## What and Why

Study of two exotic states through the chain

$$e^+e^- \rightarrow (\Upsilon(4660) \rightarrow) Z_c(4430) \pi \rightarrow \psi(2S) \pi \pi \rightarrow J/\psi \pi \pi \pi \pi \rightarrow 2\ell 4\pi$$

**$Z_c(4430)$**  was **observed** and studied in the B meson decays in the  $\pi\psi(2S)$  invariant mass **by BELLE** [PRD **88**, 074026] (and by LHCb [PRL **112**, 222002])

**$\Upsilon(4660)$** , already **observed by BaBar** [PRD **89**, 111103(R)] and **BELLE** [PRD **91**, 112007], was **hypothesised** to be a **baryonium**

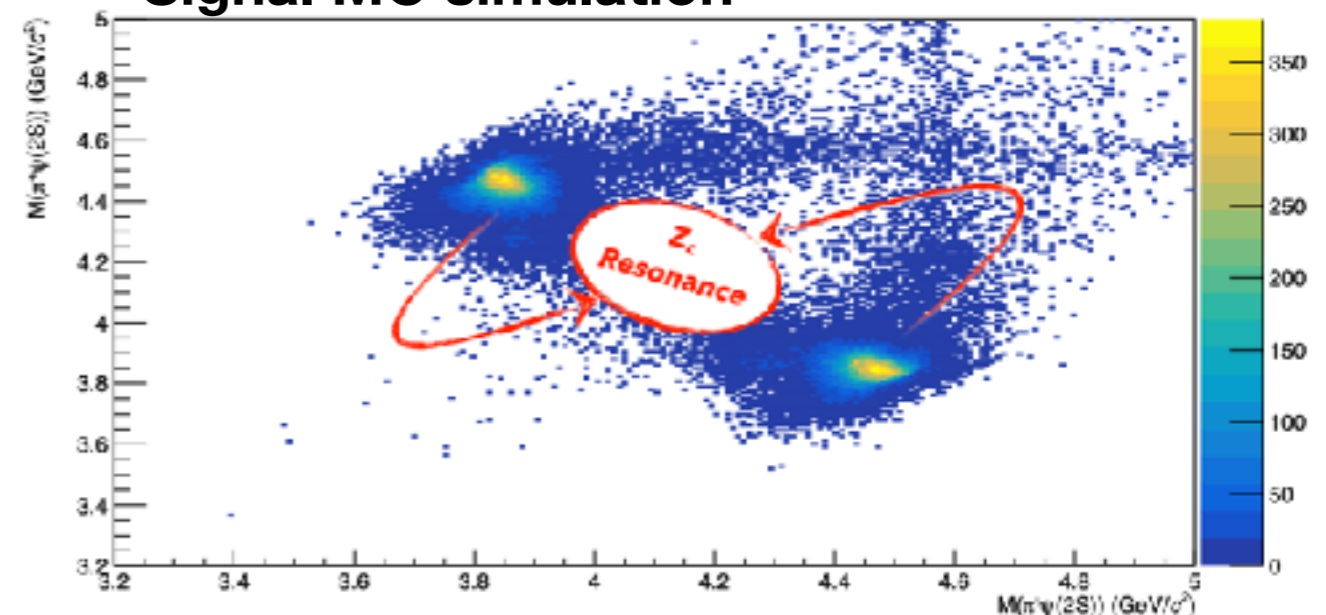
## HOW

The study will make use of the  **$\sim 5 \text{ fb}^{-1}$**  data  
@  $\sqrt{s} > 4.6 \text{ GeV}$

No  $Z_c(4430)$  signal was observed in the mono-energetic datasets,  
so the main idea is to merge all the data  
@  $\sqrt{s} > 4.6 \text{ GeV}$  to use the whole statistics

- Optimization of event and track selection (almost done)
- Off-peak data sets and background studies
- Systematic uncertainties

## Signal MC simulation



# ARRIA V GX > CANDIDATES FOR REPLACEMENT

## 1) Cyclone V GT dev. kit Intel DK-DEV-5CGTD9N:

- onboard FPGA: 5CGTDF9E5F35C7N; year launched: 2011; TSMC's 28nm technology
- Status: active; cost: 1.162,73€ (current, Digikey)
- porting of GEMROC FPGA firmware (A.C.R.): fits with timing closure warnings

## 2) Cyclone V SX SoC dev. kit Critical Link MitySOM-5CSX:

- onboard FPGA: 5CSXFC6C6U23C7N (SoC); year launched: 2012
- Status: active; cost: 804,69€ (current, Digikey)
- porting of GEMROC FPGA firmware (A.C.R.): unsuccessful due to insufficient I/O

## 3) Cyclone V SX SoC dev. kit Intel DK-DEV-5CSXC6N:

- onboard FPGA: 5CSXFC6D6F31C6N (SoC) ; year launched: 2011
- Status: active; cost: 1.606,71€ (current, Digikey)
- porting of GEMROC FPGA firmware (A.C.R.): fits with timing closure warnings for more pessimistic timing corners

## 4) Cyclone 10 GX dev. kit Trenz TEI0006-03-220-5I:

- onboard FPGA: 10CX220YF780I5G; year launched: 2017; TSMC's 20nm technology
- Status: active; cost: 498,00€ (current, Trenz)
- accessory carrier board Trenz TEIB0006-02 cost: 179,00€ (current, Trenz)
- porting of GEMROC FPGA firmware (A.C.R.): in progress – needs Quartus Pro Edition

## 5) Cyclone 10 GX dev. kit Intel DK-DEV-10CX220-A:

- onboard FPGA: 10CX220YF780E5G; year launched: 2017; TSMC's 20nm technology
- Status: active; cost: 1.074,12€ (current, Digikey)
- porting of GEMROC FPGA firmware (A.C.R.): in progress – needs Quartus Pro Edition

Neither with the same footprint

Analysis of pros/cons

Detailed evaluation of fw porting

A solution with some compromises can be found

